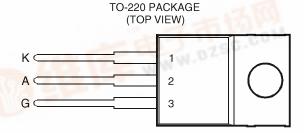


#### SC12 SERIES SILICON CONTROLLED RECTIFIERS

- 12 A Continuous On-State Current
- 100 A Surge-Current
- **Glass Passivated Wafer**
- 400 V to 800 V Off-State Voltage
- Max IGT of 20 mA



Pin 2 is in electrical contact with the mounting base.

#### absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
The state of the s	SC12-400-100 SC12-600-100 SC12-700-100 SC12-800-100	V <sub>DRM</sub>	400 600 700 800	V
Repetitive peak reverse voltage SC12-400-100 SC12-600-100 SC12-700-100 SC12-800-100			400 600 700 800	V
Continuous on-state current at (or below) 70°C case temperature (see Note 1)		I <sub>T(RMS)</sub>	12	Α
Average on-state current (180° conduction angle) at (or below) 70°C case temper (see Note 2)	ature	I <sub>T(AV)</sub>	7.5	Α
Surge on-state current at (or below) 25°C case temperature (see Note 3)		I <sub>TM</sub>	100	Α
Peak positive gate current (pulse width ≤ 300 μs)		I <sub>GM</sub>	3	Α
Peak gate power dissipation (pulse width ≤ 300 μs)		P <sub>GM</sub>	5	W
Average gate power dissipation (see Note 4)		P <sub>G(AV)</sub>	1	W
Operating case temperature range		T <sub>C</sub>	-40 to +110	°C
Storage temperature range		T <sub>stg</sub>	-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds		TL	230	°C

- NOTES: 1. These values apply for continuous dc operation with resistive load. Above 70°C derate linearly to zero at 110°C.
  - 2. This value may be applied continuously under single phase 50 Hz half-sine-wave operation with resistive load. Above 70°C derate linearly to zero at 110°C.
  - 3. This value applies for one 50 Hz half-sine-wave when the device is operating at (or below) the rated value of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. WWW.DZSC.COM
  - 4. This value applies for a maximum averaging time of 20 ms.



### SILICON CONTROLLED RECTIFIERS

#### electrical characteristics at 25°C case temperature (unless otherwise noted)

	PARAMETER		TEST CONDITI	ONS	MIN	TYP	MAX	UNIT
I <sub>DRM</sub>	Repetitive peak off-state current	V <sub>D</sub> = rated V <sub>DRM</sub>		T <sub>C</sub> = 110°C			2	mA
I <sub>RRM</sub>	Repetitive peak reverse current	V <sub>R</sub> = rated V <sub>RRM</sub>	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C			2	mA
I <sub>GT</sub>	Gate trigger current	V <sub>AA</sub> = 12 V	$R_L = 100 \Omega$	t <sub>p(g)</sub> ≥ 20 μs		8	20	mA
V <sub>GT</sub> Gate trigger vol		$V_{AA} = 12 \text{ V}$ $t_{p(g)} \ge 20  \mu\text{s}$	$R_L = 100 \Omega$	T <sub>C</sub> = - 40°C			2.5	
	Gate trigger voltage	$V_{AA} = 12 \text{ V}$ $t_{p(g)} \ge 20  \mu\text{s}$	$R_L = 100 \Omega$			0.8	1.5	V
		$V_{AA} = 12 \text{ V}$ $t_{p(g)} \ge 20  \mu\text{s}$	$R_L = 100 \Omega$	T <sub>C</sub> = 110°C	0.2			
I <sub>H</sub> Holdin	Holding current	$V_{AA} = 12 \text{ V}$ Initiating I <sub>T</sub> = 100 mA		T <sub>C</sub> = - 40°C			100	mA
	Troiding durions	$V_{AA} = 12 \text{ V}$ Initiating $I_T = 100 \text{ mA}$					40	
V <sub>T</sub>	On-state voltage	I <sub>T</sub> = 12 A	(see Note 5)				1.4	V
dv/dt	Critical rate of rise of off-state voltage	V <sub>D</sub> = rated V <sub>D</sub>	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C		400		V/µs

NOTE 5: This parameter must be measured using pulse techniques, t<sub>p</sub> = 300 µs, duty cycle ≤ 2 %. Voltage sensing-contacts, separate from the current carrying contacts, are located within 3.2 mm from the device body.

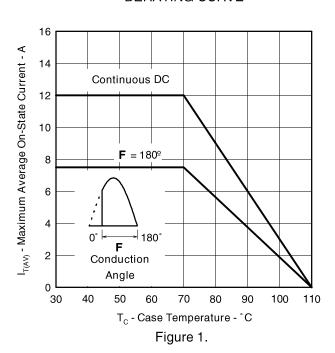
#### thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.4	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

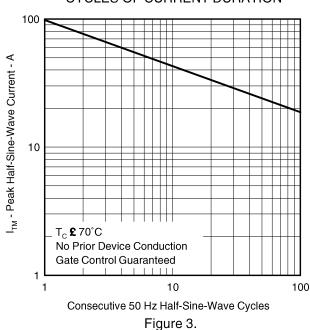
#### SILICON CONTROLLED RECTIFIERS

#### THERMAL INFORMATION

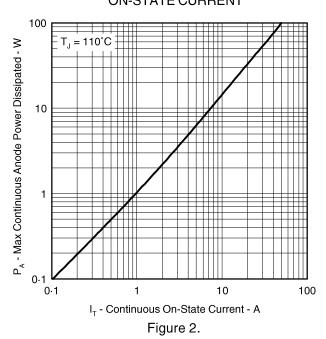
# AVERAGE ON-STATE CURRENT DERATING CURVE



SURGE ON-STATE CURRENT
vs
CYCLES OF CURRENT DURATION



#### MAX ANODE POWER LOSS vs ON-STATE CURRENT



# TRANSIENT THERMAL RESISTANCE vs

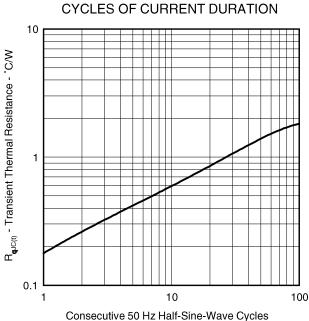
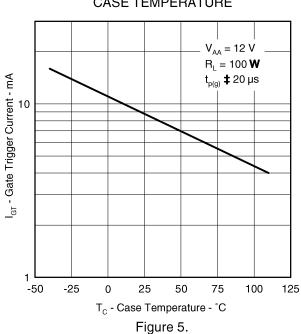


Figure 4.

#### **TYPICAL CHARACTERISTICS**

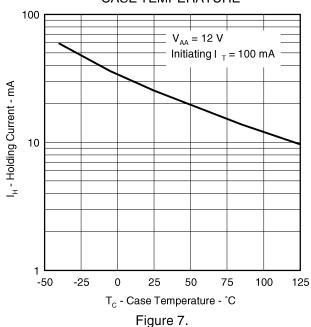


#### CASE TEMPERATURE

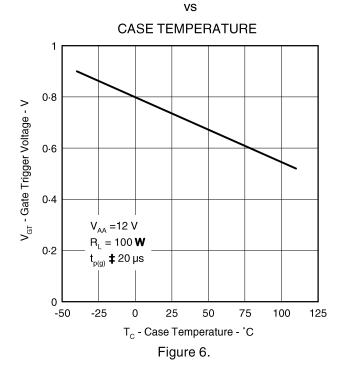


#### HOLDING CURRENT vs

#### **CASE TEMPERATURE**



## **GATE TRIGGER VOLTAGE**



## PEAK ON-STATE VOLTAGE PEAK ON-STATE CURRENT

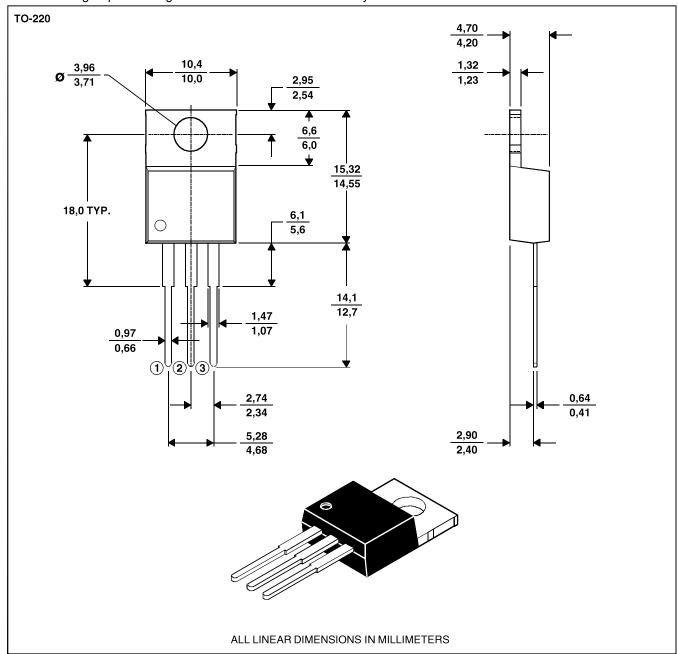
## 2.5 $T_C = 25 \,^{\circ}C$ $t_{p} = 300 \, \mu s$ V<sub>™</sub> - Peak On-State Voltage - V Duty Cycle £2 % 1.5 1 0.5 0 0.1 100

I<sub>TM</sub> - Peak On-State Current - A Figure 8.

#### **MECHANICAL DATA**

## TO-220 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.